GaNSafe™ The World's Safest GaN Power Semiconductor

Corporate Introduction

David Carroll Sr. VP Worldwide Sales

Taipei, September 2023 ir@navitassemi.com

Navitas Electrify Our World™



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Disclaimers



This presentation includes "forward-looking statements" within the meaning of Section 21E of the Securities Exchange Act of 1934, as amended. Forward-looking statements may be identified by the use of words such as "we expect" or "are expected to be," "estimate," "plan," "project," "forecast," "intend," "anticipate," "believe," "seek," or other similar expressions that predict or indicate future events or trends or that are not statements of historical matters. These forward-looking statements include, but are not limited to, statements regarding estimates and forecasts of other financial and performance metrics and projections of market opportunity and market share. These statements are based on various assumptions, whether or not identified in this presentation. These statements are also based on current expectations of our management and are not predictions of actual performance. Such forward-looking statements are provided for illustrative purposes only and are not intended to serve as, and must not be relied on by any investor as, a guarantee, an assurance, a prediction or a definitive statement of fact or probability. Actual events and circumstances are difficult or impossible to predict and will differ from assumptions and expectations. Many actual events and circumstances that affect performance are beyond our control. Forward-looking statements are subject to a number of risks and uncertainties, including the possibility that the expected growth of our business will not be realized, or will not be realized within expected time periods, due to, among other things, the failure to successfully integrate acquired businesses into our business and operational systems; the effect of acquisitions on customer and supplier relationships or the failure to retain and expand those relationships; the success or failure of other business development efforts; our financial condition and results of operations; our ability to accurately predict future revenues for the purpose of appropriately budgeting and adjusting our expenses; our ability to diversify our customer base and develop relationships in new markets; our ability to scale our technology into new markets and applications; our ability to realize our potential pipeline opportunities; the effects of competition on our business, including actions of competitors with an established presence and resources in markets we hope to penetrate, including silicon carbide markets; the level of demand in our customers' end markets, both generally and with respect to successive generations of products or technology; our ability to attract, train and retain key qualified personnel; changes in government trade policies, including the imposition of tariffs; the impact of the COVID-19 pandemic on our business, results of operations and financial condition: the impact of the COVID-19 pandemic on the global economy, including but not limited to our supply chain and the supply chains of customers and suppliers; regulatory developments in the United States and foreign countries; and our ability to protect our intellectual property rights. These and other risk factors are discussed in the Risk Factors section beginning on p. 15 of our annual report on Form 10-K for the year ended December 31, 2022, which we filed with the Securities and Exchange Commission (the "SEC") on April 3, 2022 and as thereafter amended, and in other documents we file with the SEC, including our quarterly reports on Form 10-Q. If any of these risks materialize or our assumptions prove incorrect, actual results could differ materially from the results implied by these forward-looking statements. There may be additional risks that we are not aware of or that we currently believe are immaterial that could also cause actual results to differ materially from those contained in the forward-looking statements. In addition, forward-looking statements reflect our expectations, plans or forecasts of future events and views as of the date of this presentation. We anticipate that subsequent events and developments will cause our assessments to change. However, while we may elect to update these forward-looking statements at some point in the future, we specifically disclaim any obligation to do so. These forward-looking statements should not be relied upon as representing our assessments as of any date subsequent to the date of this presentation.

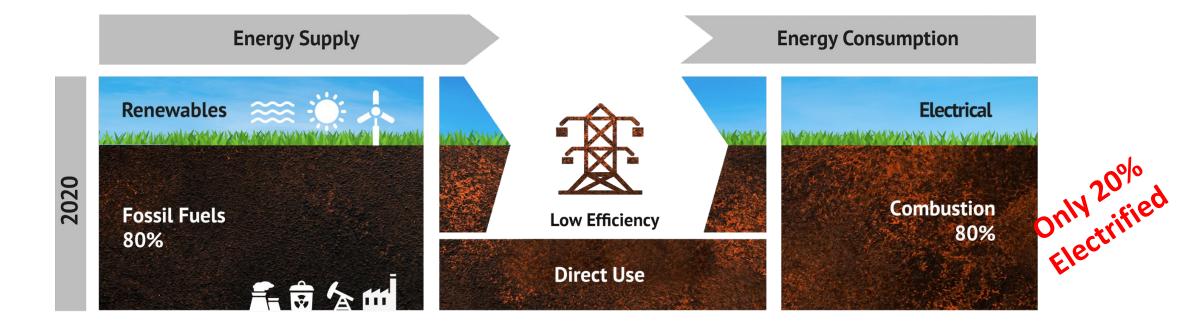
This presentation also contains estimates and other statistical data made by independent parties and by us relating to market size and growth and other data about our industry. This data involves a number of assumptions and limitations, and you are cautioned not to give undue weight to such estimates. Neither we nor any other person makes any representation as to the accuracy or completeness of such data or undertakes any obligation to update such data after the date of this presentation. In addition, projections, assumptions and estimates of our future performance and the future performance of the markets in which we operate are necessarily subject to a high degree of uncertainty and risk.

For further information with respect to our company, we refer you to our most recent annual report on Form 10-K and our most recent quarterly report on Form 10-Q, filed with the SEC. In addition, we are subject to the information and reporting requirements of the Securities Exchange Act of 1934, as amended, and, accordingly, we file periodic reports, current reports, proxy statements and other information with the SEC. These periodic reports, current reports, proxy statements and other information are available for review at the SEC's website at http://www.sec.gov.

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The Fossil Fuel Challenge



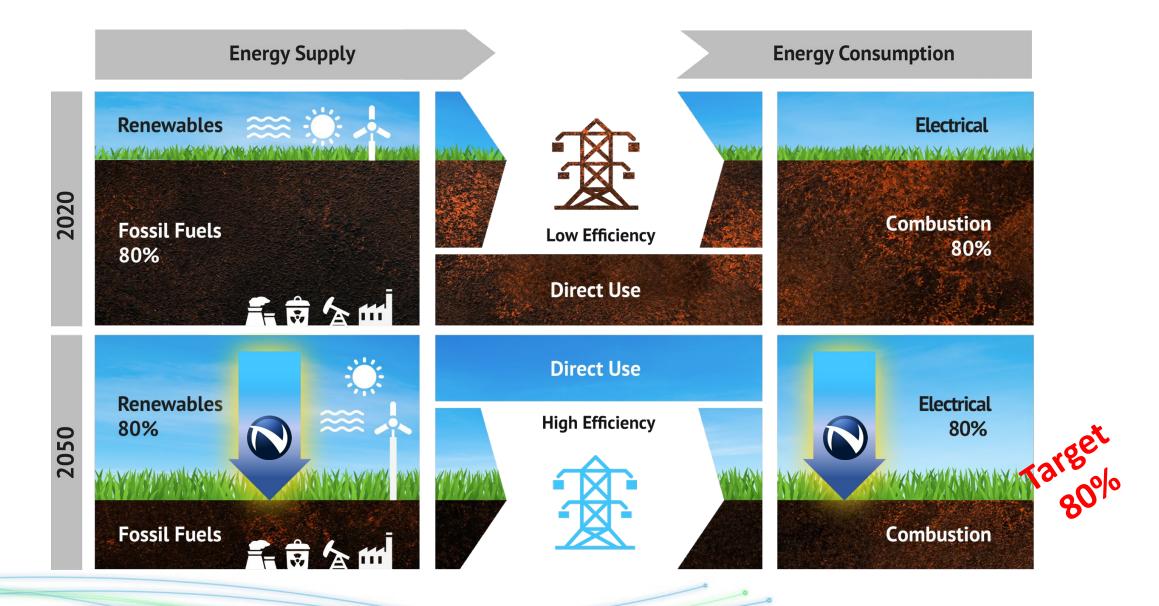


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Electrify Our World[™]





Pure-Play, Next-Gen Power Semiconductors



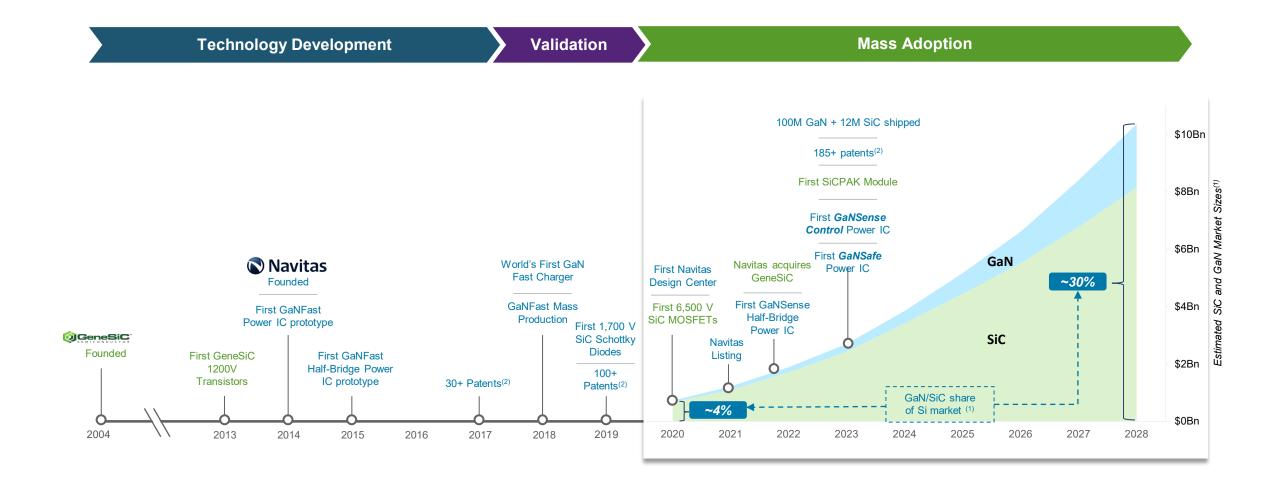


Statistical data is based on Navitas estimates of GaN-based systems compared to Si-based estimates in the 2024-2025 timeframe. Based on Navitas measurements of select GaN-based mobile wall chargers compared to Si-based chargers with similar output power, incl.
 2019 study of 65W fast chargers, 2022 customer statement re 2.7 kW data center AC-DC

2. Navitas estimates based on customer feedback as the expected system cost saving overtime as of April 2023

Right Time, Right Technology, Right Company



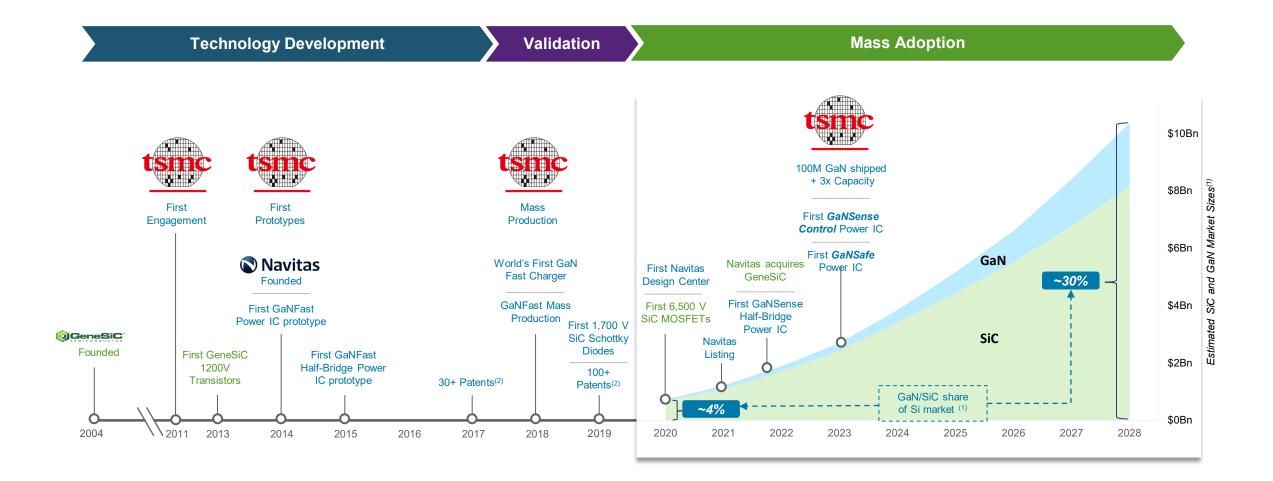


1. Estimated based on Power SiC/GaN Compound Semiconductor Market Monitor, Q1 2023, Yole Intelligence

2. Granted or pending

Right Partnership: Navitas + TSMC





1. Estimated based on Power SiC/GaN Compound Semiconductor Market Monitor, Q1 2023, Yole Intelligence

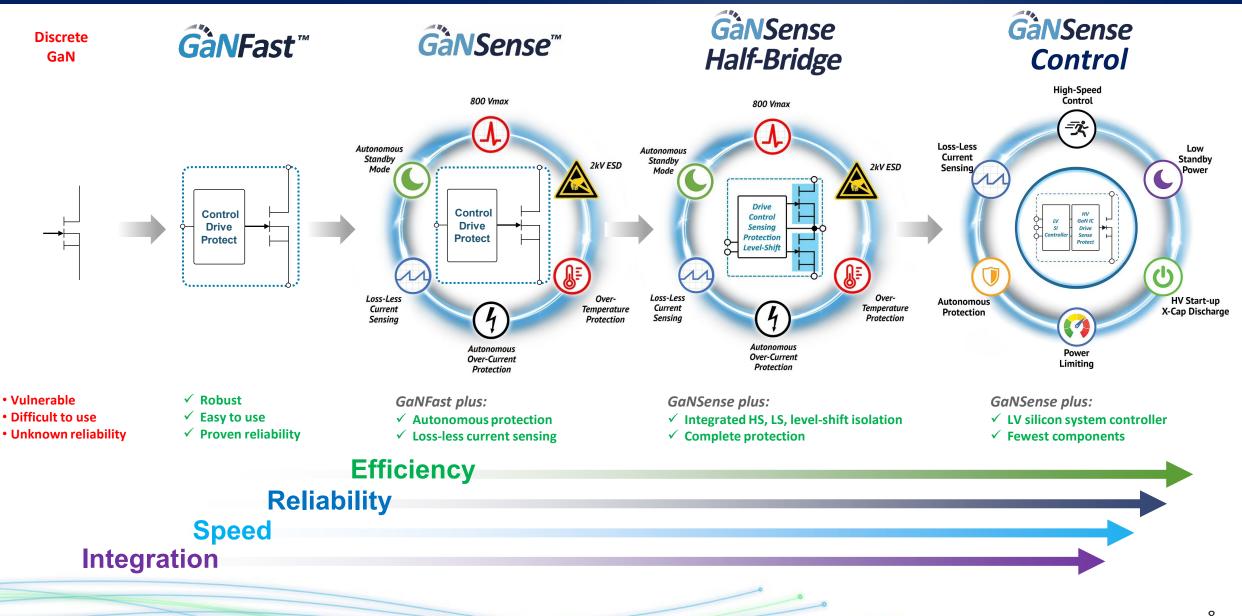
2. Granted or pending

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GaNFast[™] Technology Leader, Market Leader



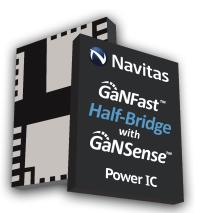






100,000,000+ Shipped!

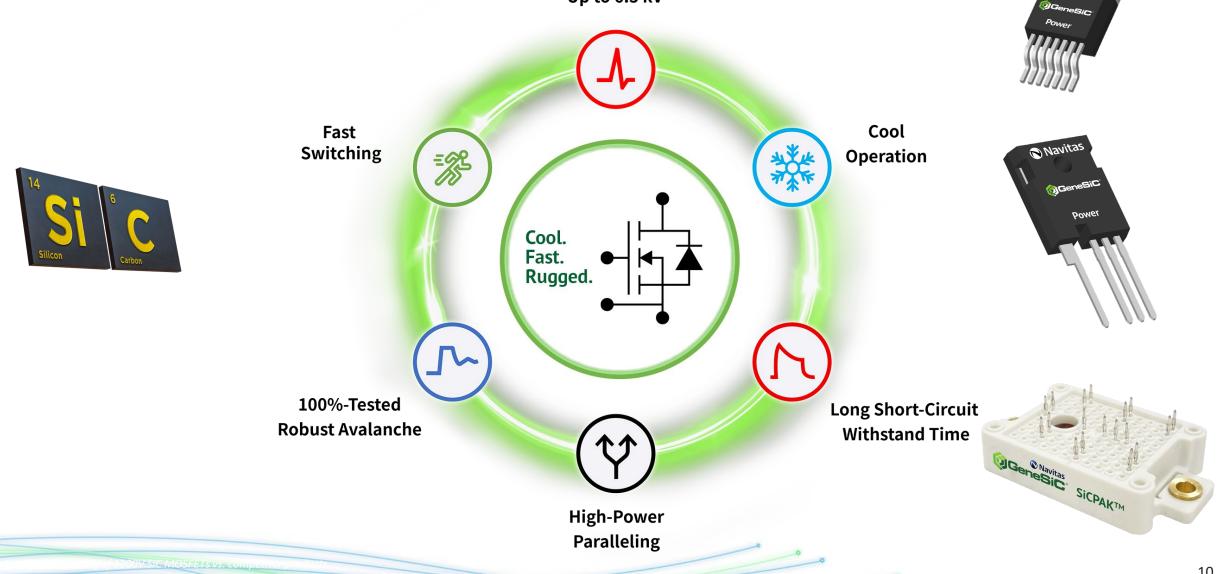








GeneSiC^{*} Highest Performance, Voltage Range & Ruggedness



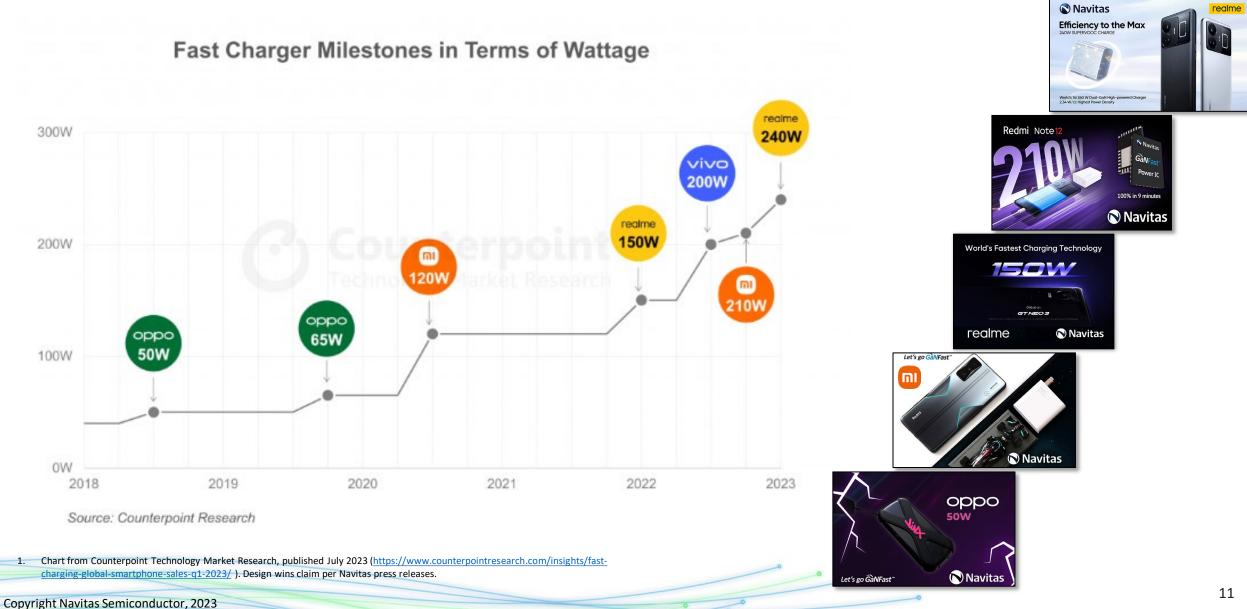
Up to 6.5 kV

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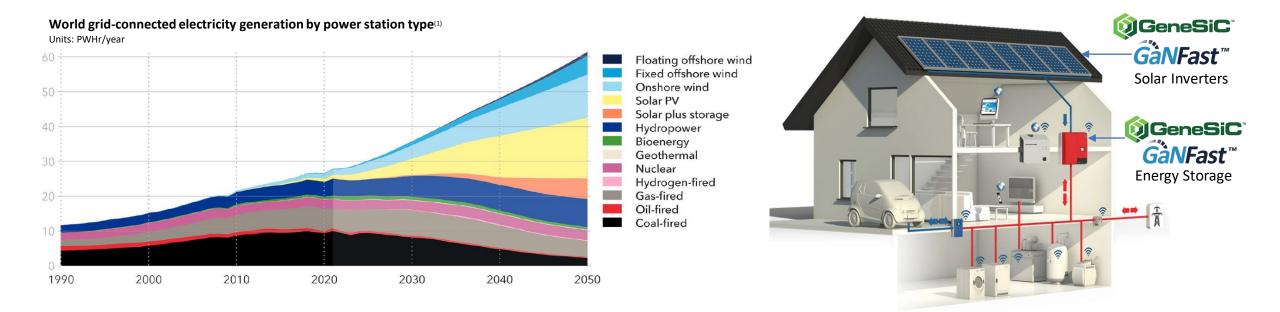
🔊 Navitas

Accelerating Mobile: Navitas wins 100% Milestones⁽¹⁾



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Accelerating Energy Demand, Accelerating Solar/Storage 🔊 Navitas



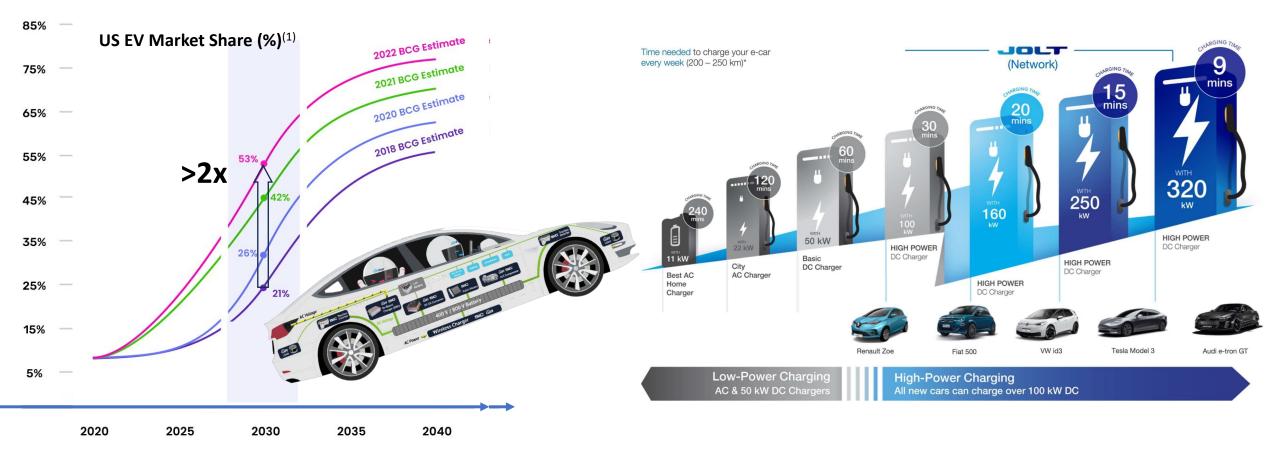
- Global electricity supply +2.3x by 2050⁽¹⁾
- Solar / energy-storage systems (ESS) up from ~2% to 38%⁽²⁾
- Energy storage critical to balance supply / demand



2. DNV: Solar/ESS grows to 38% of supply by 2050. Historical data per IEA WEB (2022), GlobalData (2022)



Accelerating EV: Faster Charging (OBC and Roadside)



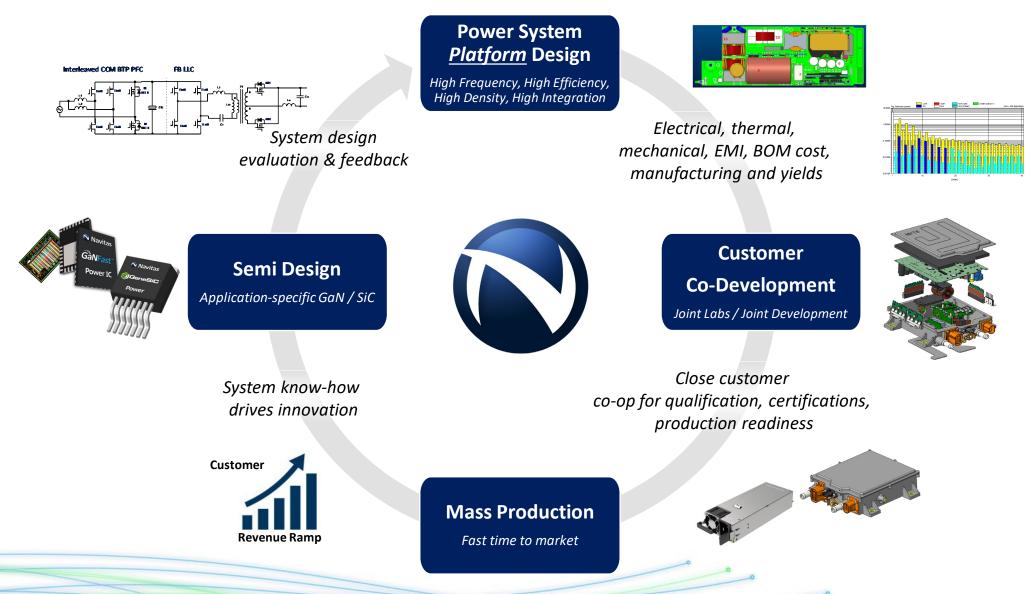
1. Chart BCG, via https://www.recurrentauto.com/research/ev-adoption-us

2. https://jolt.energy/whats-the-difference-between-ac-dc-and-ultra-fast-charging/

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Accelerating Time-to-Market: Unique System Design Centers



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Accelerating \$1B^{⁽²⁾Customer Pipeline, Diverse markets}



Mobile / Consumer	Data Center	Solar / Energy Storage Systems	EV / eMobility	Appliance / Industrial		
Top 5/5 smartphone OEMs and top 5/5 notebook OEMs in development or production ⁽¹⁾	Tier-1 PSU ODMs in development ⁽¹⁾	Majority of top 10 OEMs engaged ⁽¹⁾	Tier-1 customers and engagements ⁽¹⁾	Top 7/10 OEMs engaged ⁽¹⁾		
ANKERDetteLenovoOPPOSAMSUNGImit xiaomit	Power System EngagementsEnd Customer TargetsImage: Complex	KATEK Brond CanadianSolar SUNGROW GROWATT Clean power for all GROWATT Bloomenergy Excenses power	BorgWarner MOBIS ABB GEELY -chargepoint ↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓↓	In Development		

• Q2 2023: Pipeline up 30% to \$1 billion, with more projects, more \$ potential in all markets

1. Navitas estimates of top OEMs in each respective market and their existing customer engagements. Appliance/Induustrial 'top 10' based on Navitas estimate

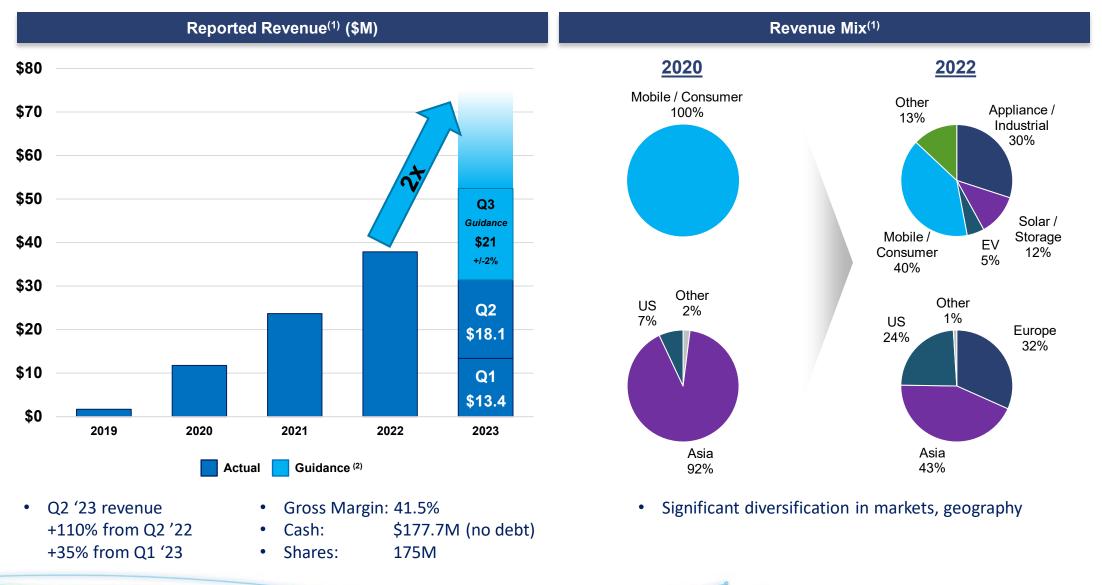
2. "Pipeline opportunity" reflects estimated potential future business based on interest expressed by potential customers for qualified programs, stated in terms of estimated revenue that may be realized in one or more future periods. Pipeline opportunity is not a proxy for backlog or future revenue or other measure or indicator of financial performance. Rather, Navitas uses customer pipeline as a statistical metric to indicate relative changes in future potential business across various product markets. Time horizons vary accordingly, based on product type and application. Actual business across various product markets and other factors.

- and application. Actual business realized depends on ultimate customer selection, program share and other factors
- 3. Navitas estimates for potential customer revenue across GaN or SiC in the market stated

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Accelerating Growth & Diversity





1. Reported revenue not pro forma for GeneSiC financials for the period prior to the close of the acquisition of GeneSiC on 8/15/2022. Only includes GeneSiC revenue for the period post transaction close (8/15/2022 – 12/31/2022)

2. Q3'23 and CY2023 guidance as of 8-14-23 only. Not updated

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Accelerating Sustainability





February '22 First GaN sustainability report based on global standards.

Every GaNFast[™] IC

saves

4 kg CO₂



4x-10x lower component CO₂ footprint than silicon

28% lower lifetime CO₂ footprint for chargers / adapters

Accelerates transition from ICE to EV by **3 years**, saving **20%/yr** of road-sector emissions by 2050

GaN + SiC save up to 6 Gton / year by 2050



May '22 World's first semiconductor company CarbonNeutral® certified



August '22 First 100,000 tons CO₂ saved (Over 170,000 as of August 2023)



Navitas 🔊

October '22 Recognized for industry-leading sustainability reporting

GaNSafe™ The World's Safest GaN Power Semiconductor

Technology Introduction

Charles Bailley Sr. Director Business Development

Taipei, September 2023 ir@navitassemi.com Davitas Electrify Our World™

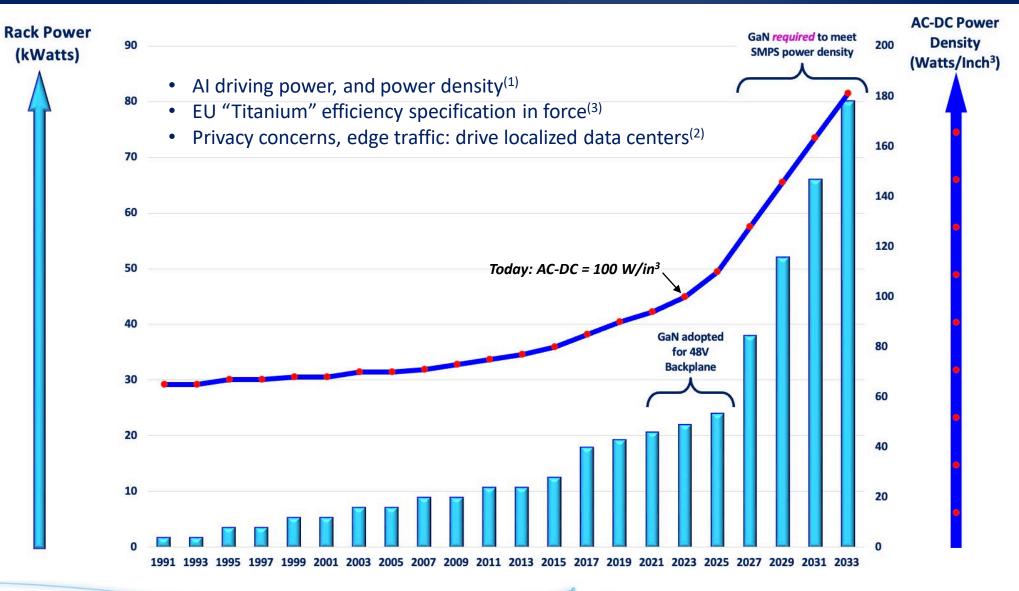


Accelerating Data Center Power, Efficiency





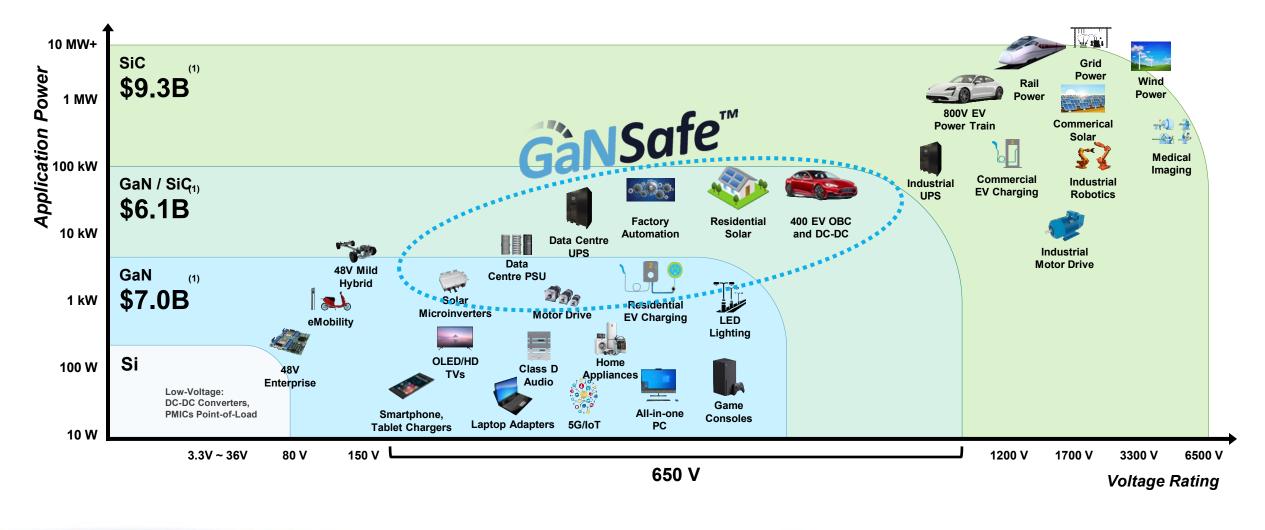




- 1. Cerebras white paper / website
- 2. TD Cowen, per "Al to drive data center investments", LightReading.com, 4-26-23
- 3. European Union 'Directive 2009/125/EC, 2019 Annex', power supplies must be >96% efficiency peak, as of 1-1-23
- Copyright Navitas Semiconductor, 2023

GaNSafe[™]: Accelerating GaN to High Power

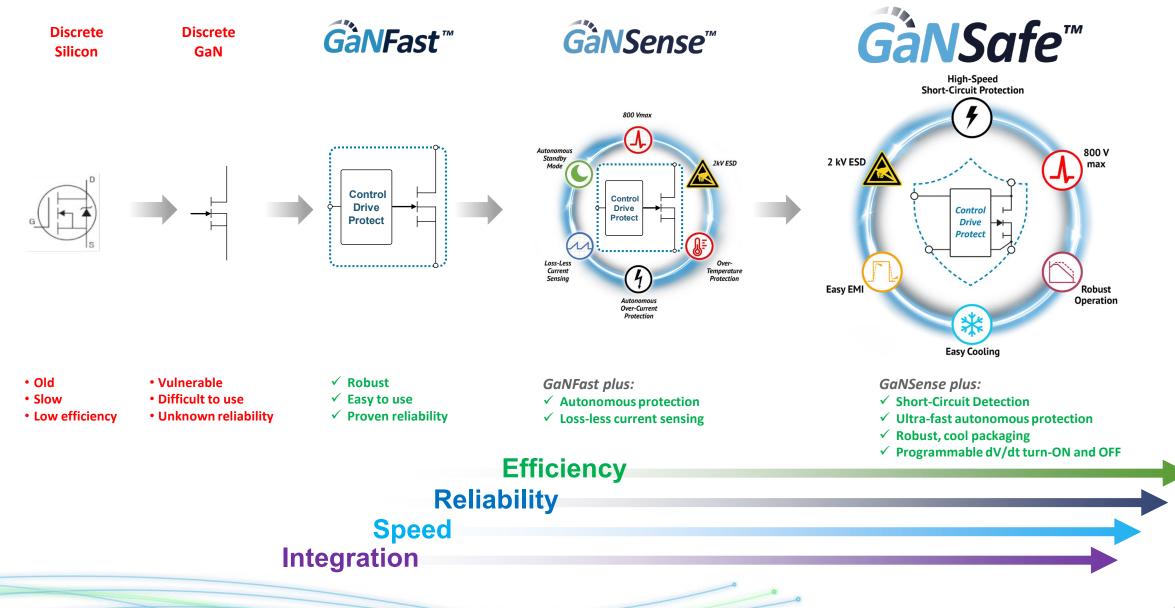




1. Navitas company estimates, potential market opportunity in 2026 is \$22B+ for GaN and SiC, replacing certain of the silicon market share. Axes not to scale

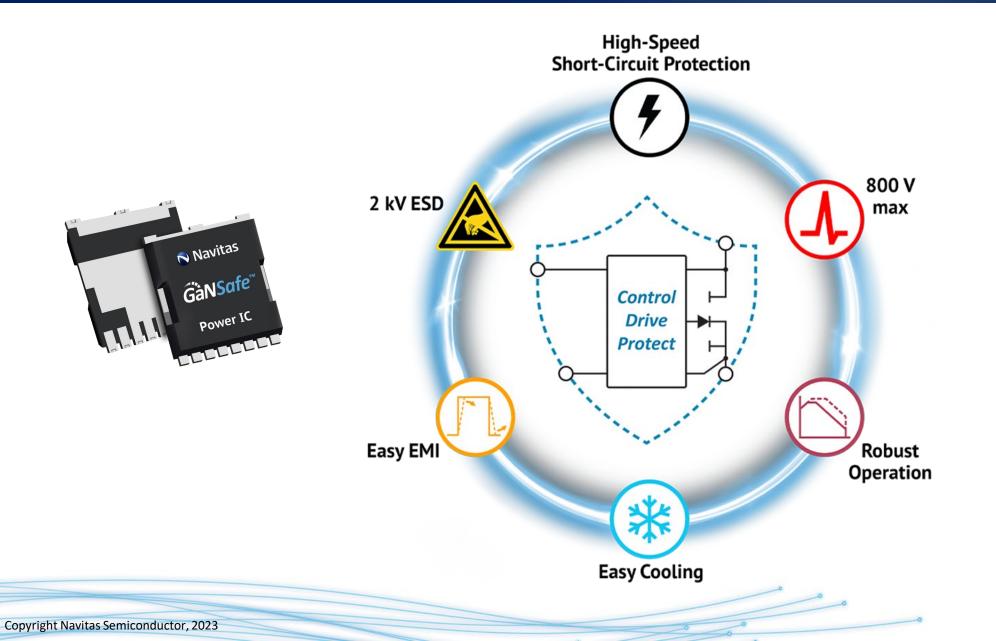
GaNSafe[™]: Ultimate Performance and Reliability

Navitas

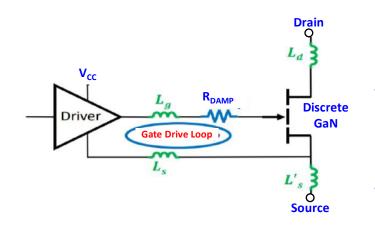


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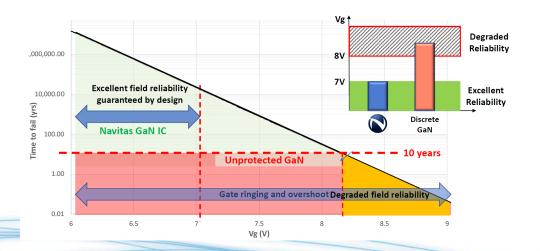
GaNSafeTM: The World's Safest GaN Power Semiconductor Navitas

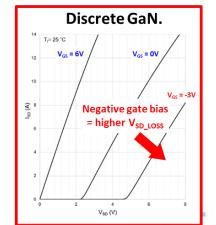


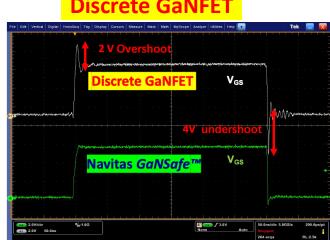
From GaNFast[™] to GaNSafe[™], Max 4th-Gen Reliability



- Discrete GaN = high risk
 - Weak gate, high loop inductance
 - Shoot-thru risk multiplied by increased di/dt in high-power applications
- **GaNFast**[™] integrated, regulated gate drive, <u>zero</u> loop inductance
- Fewer components, smaller PCB,
- Higher efficiency, lower system cost
- **GaNSafe**[™] optimized for high power
- More protection (300 ns Desat SCP, OTP, UVLO, ESD, etc.)
- More control (dV/dt ON & OFF, etc.)
- Industry-standard, robust, cool packaging





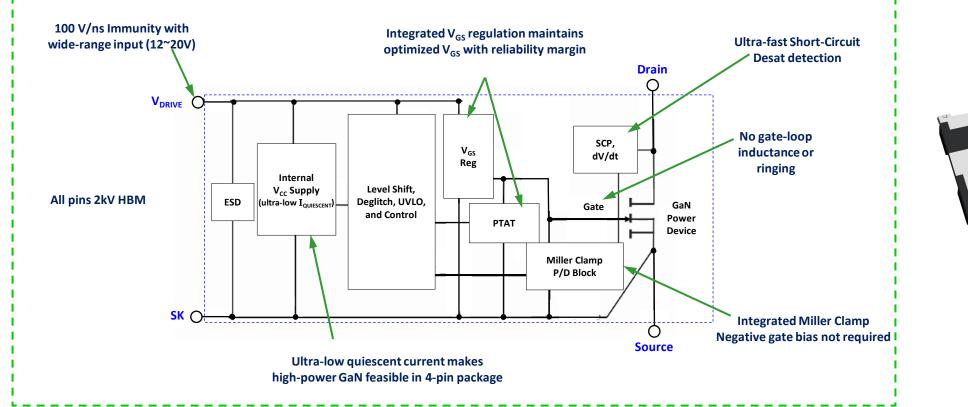


Discrete GaNFE1

Navitas

GàNSafe[™]: Reliable high-power in only 4 pins







GaNSafe[™] Delivers High-Power Reliability

V_{DS}

29.991 µs

H 5.00 ns/

29.996 µs

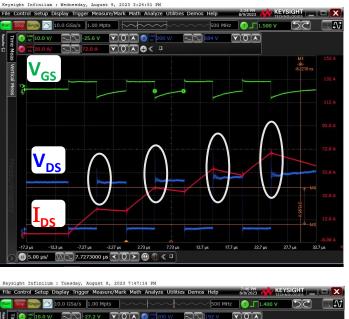


Double-pulse test: ٠ 400 V, 70 A, R_{SERIES} = 11 mΩ

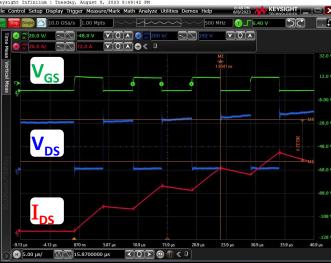


Discrete GaN $42 \text{ m}\Omega \text{ max}$

Significant spikes Excessive turn-ON ringing 250 V undershoot











ĜàNSafe™

 $45 \text{ m}\Omega \text{ max}$ (NV6513)

No voltage spikes No ringing No undershoot

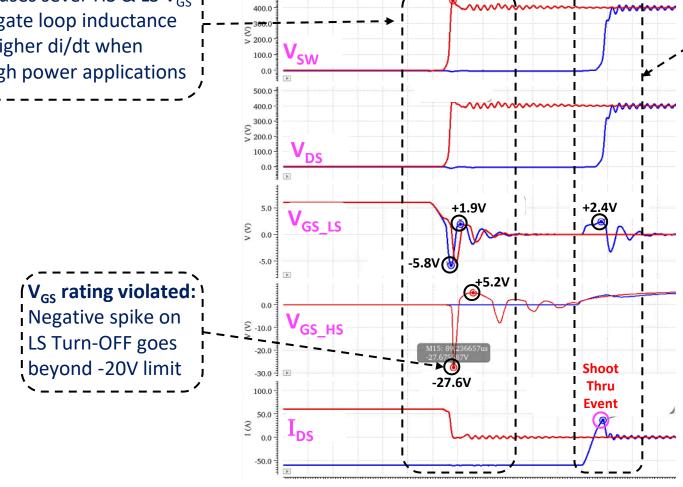
Discrete GaN Has Major Problems in High Power

500.0



Boost Mode:

LS Turn-OFF causes sever HS & LS V_{GS} ringing due to gate loop inductance coupled with higher di/dt when operating in high power applications



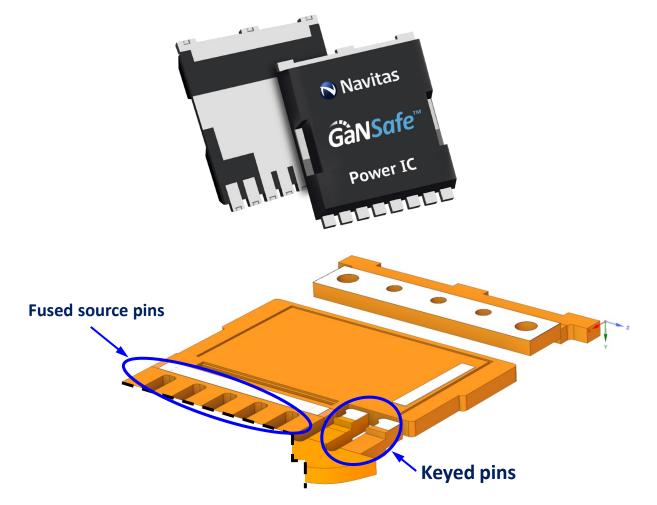
Buck Mode: LS gate is pulled-up as Switch Node rises, with simultaneous surge in I_{DS}

400V 60A Simulation:

- Discrete GaN
- 25mΩ
- TOLL

GaNSafe[™]: TOLL = Robust, Reliable Packaging





L. IPC-9701 "Thermal Cycling Test Method for Fatigue Life Characterization of Surface Mount Attachments"

- TOLL = "Transistor Outline Lead-Less"
- 10 x 10 mm
- Mechanically robust, novel leadframe
 - Keyed V_{DRIVE} and SK pins
 - Improved mechanical performance
 - Fused source pins
 - Improved thermals)
 - Passed IPC-9701 for long mechanical lifetime

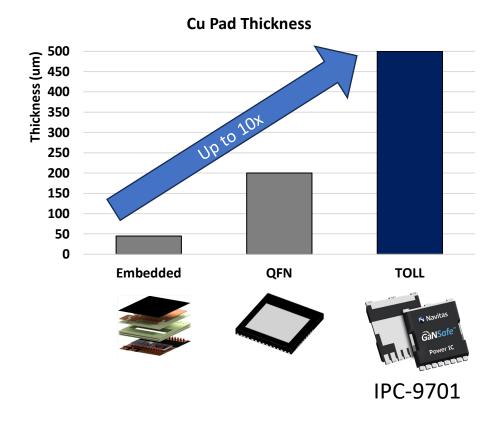


GàNSafe™

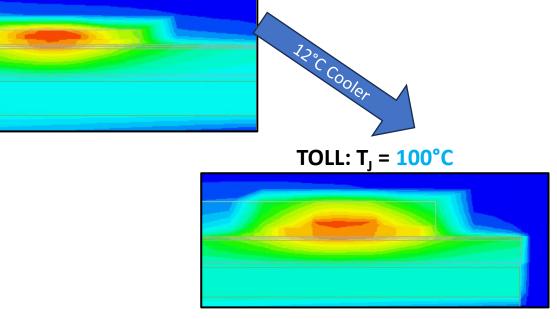
Integrated GaN gate drive, protection and features, in 4-pin industry-standard thermally-enhanced package...

GàNSafe[™] Optimized System-Level Cooling





QFN: T_j = **112°C**



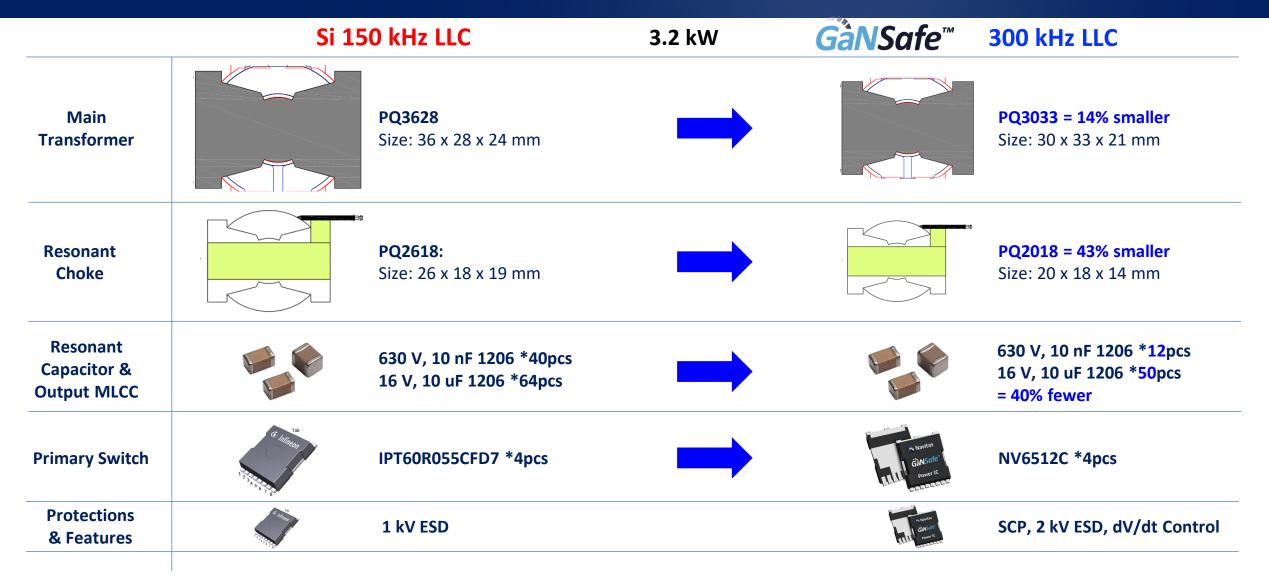
GàNSafe™

- Optimized, system-level cooling (R_{Θ_J-A})
 Larger, thicker Cu pad
 - •High-conductivity die attach

1. Navitas' simulated temperature gradients for TOLL and QFN under identical system thermal design and 200 LFM airflow

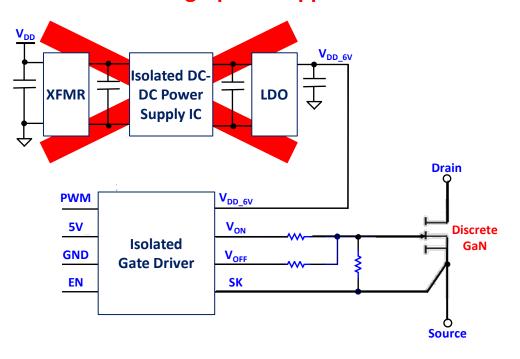
GàNSafe[™] Yields Higher Density, Lower System Cost





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Typical GaN discrete high-side schematic for use in high-power applications:



Eliminate costly DC-DC supply

- GaNSafe™
 - Use Boot Strap for high power applications:

\$1 saved per half-bridge

- Integrated Miller Clamp,
- no negative gate drive (V_{GS})
- Includes SCP protection and 2 kV ESD

Navitas

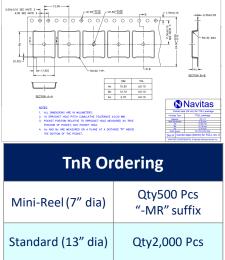


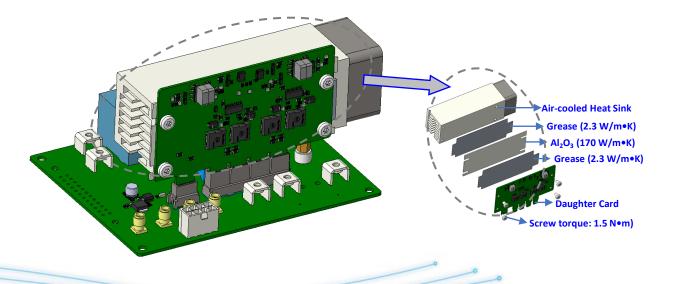
Reference	Туре	Robust Package	Minimum Pin-Count	Large Cooling Pad	Easy Cooling (Low R _{th})	Robust High Voltage (V _{DS})	Robust Integrated Gate Drive	Robust Gate Voltage	Over Temp Protection		Robust ESD (HBM)	Robust ESD (CDM)	Robust dV/dt	Easy EMI
GầNSafe™	GaN Power IC	TOLL	4	50 mm ²	0.36 K/W	800 V	Y	20 V	Y	50 ns	2 kV	1 kV	100 V/ns	(ON,OFF)
Company A	Discrete GaN	TOLL												
В	Discrete GaN	QFN												
С	Discrete GaN	QFN												
D	Discrete GaN	TOLL												
E	Discrete GaN	GaNPX												
F	MCM GaN	High-pin QFN												
G	MCM GaN	High-pin QFN												

GàNSafe[™]: Immediate Availability⁽¹⁾



Part#	V _{DS} (Cont, Max) (V)	V _{DS} (Dyn, Max) (V)	R _{DS(ON)} (Max 25°C) (mΩ)	I _D (Max) (A)	Package	Evaluation Kit
NV6515			35	57	TOLL 10x10 Bottom-cool	
NV6513	650	000	45	48		Power Board, Full Bridge Daughter Card,
NV6512	650	800	55	34	∾ Navitas GäNSαfe [∞]	and FanSink/TIM ~ configurable for DPT or Half-Bridge testing
NV6511			98	22	Power IC	

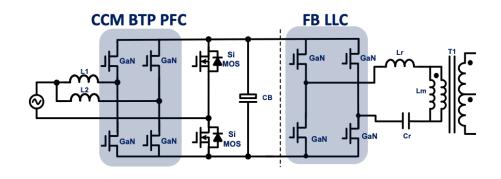




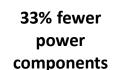
1. Samples and collateral available immediately to qualified customers

GàNSafe[™]: Maximum Performance in Data Center Power Navitas

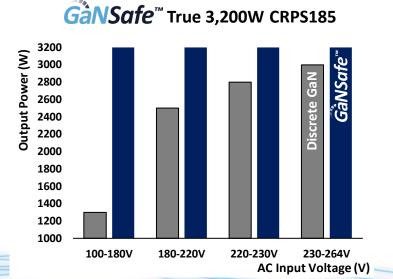
- Data center AC-DC 'silver box' (12V)
- CRPS185 form factor

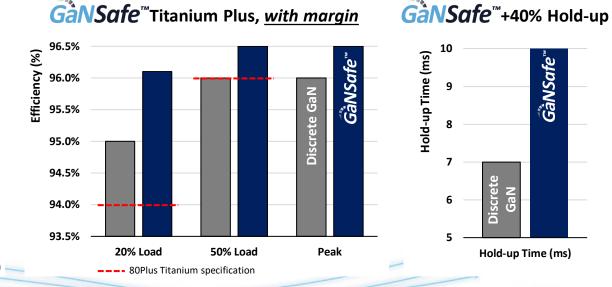




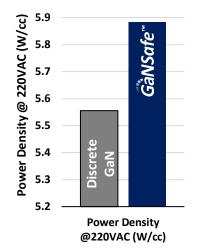


GàNSafe™





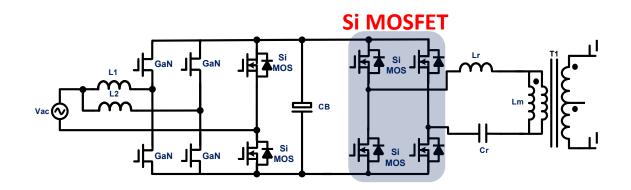
GaNSafe[™]~100W/in³

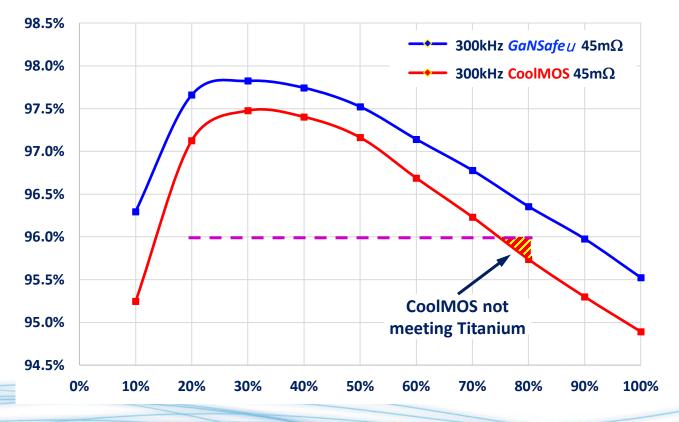


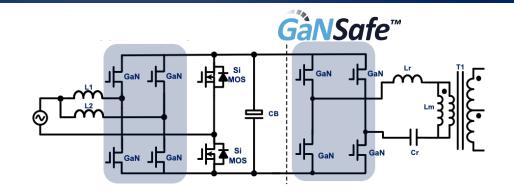
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GaNSafe[™]: Higher Efficiency than Si in 3.2kW CRPS









- GaNSafe[™] meets Titanium with higher power density at 300kHz
- CoolMOS does not meet Titanium at 300kHz F_{sw} in LLC stage
- GaNSafe[™] meets EN55022 / CISPR22 Class A (CE and RE)

GaNSafeTM Delivers Highest Power Density in EV OBC

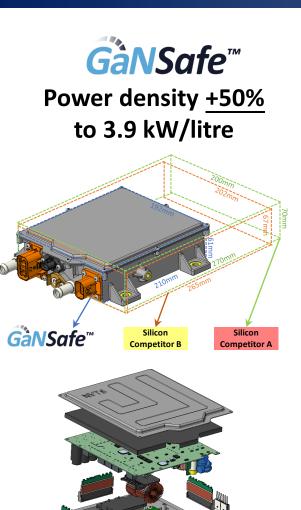
<complex-block>

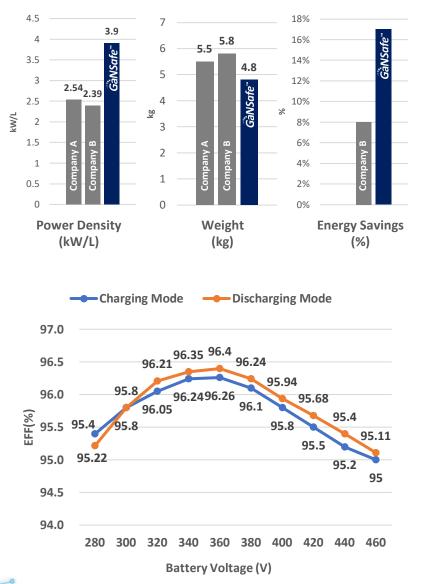
Combination 6.6 kW OBC + 3 kW DC-DC:

- AC Input: 90~265 V_{AC} up to 32 A
- **DC Output:** 470~860 V_{DC} , full load
- Power Output: 6.6 kW charging, 6.0 kVA discharging
- Efficiency: > 95% @ Full Load
- DC-DC Output: $9^{-16} V_{DC}$

Mechanical:

- **Dimensions:** 210 x 192 x 61mm (≤ 2.5 litre)
- **Cooling:** -40 to +65°C (Cold Plate)
- Communication: IP 67, CAN Bus interface

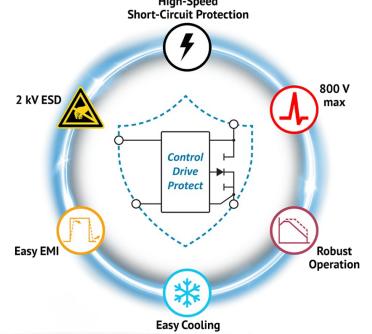




Navitas

GaNSafe[™]: World's Safest GaN Power Semiconductor





- Navitas is the industry leader in GaN
- GanFast™:
 - 100M+ shipped, 20-year warranty
- GaNSafe[™]:
 - Most protected, most reliable, safest GaN power semi
 - Benchmark efficiency, power density, reliability
 - Robust, 4-pin TOLL
 - Easy to use, fast time-to-market
 - Demonstrated performance for AI, EV, Solar and more
 - Strong customer pipeline
 - Driving GaN into high power

Navitas

Discover more at navitassemi.com

Navitas Electrify Our World™



Navitas GàNSαfe™ Power IC